

STWH13009

High voltage fast-switching NPN power transistor

Features

- High voltage capability
- Low spread of dynamic parameters
- Very high switching speed

Applications

■ Switching mode power supplies

Description

The device is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds anh high voltage capability.

It uses a Hollow Emitter structure to enhance switching speeds.

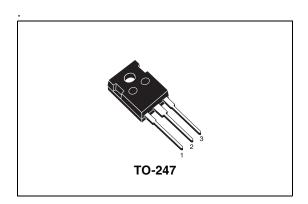


Figure 1. Internal schematic diagram

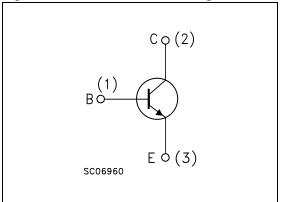


Table 1. Device summary

Order code	Marking	Package	Packaging
STWH13009	WH13009	TO-247	Tube

October 2007 Rev 1 1/9

1 Absolute maximum ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CEV}	Collector-emitter voltage (V _{BE} = -1.5V)	700	V
V _{CEO}	Collector-emitter voltage (I _B = 0)	400	V
V _{EBO}	Emitter-base voltage (I _C = 0)	12	V
I _C	Collector current	12	Α
I _{CM}	Collector peak current (t _p < ms)	24	Α
I _B	Base current	6	Α
I _{BM}	Base peak current (t _p < ms)	12	Α
P _{TOT}	Total dissipation at T _{case} = 25°C	125	W
T _{stg}	Storage temperature	-65 to 150	°C
TJ	Max. operating junction temperature	150	°C

Table 3. Thermal data

Symbol	Parameters	Value	Unit	
R _{thj-case}	Thermal resistance junction-case	max	1	°C/W

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2 Electrical characteristics

 $(T_{case} = 25^{\circ}C; unless otherwise specified)$

Table 4. Electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _{CEV}	Collector cut-off current (V _{BE} = -1.5V)	V _{CE} = 700 V V _{CE} = 700 V	T _C = 100°C			10 500	μ Α μ Α
I _{EBO}	Emitter cut-off current (I _C = 0)	V _{EB} = 10 V				10	μА
V _{CEO(sus)} ⁽¹⁾	Collector-emitter sustaining voltage (I _B = 0)	I _C = 10 mA		400			V
V _{CE(sat)} ⁽¹⁾	Collector-emitter saturation voltage	$I_C = 4 A$ $I_C = 5 A$ $I_C = 8 A$ $I_C = 12 A$	I _B = 1 A		0.2 0.25 0.35 0.6	0.5 0.6 1 2	> > >
V _{BE(sat)} ⁽¹⁾	Base-emitter saturation voltage	I _C = 5 A I _C = 8 A	_			1.2 1.6	V V
h _{FE} ⁽¹⁾	DC current gain	I _C = 5 A I _C = 8 A		18 11		30 23	
t _s	Inductive load Storage time Fall time	V _{CC} = 250 V I _{B1} = 1 A L = 200 μH			1.7 100	2.5 140	μs ns

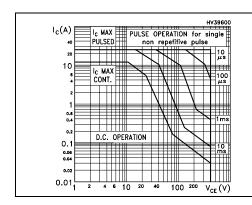
^{1.} Pulsed duration = 300 ms, duty cycle \geq 1.5%.

Electrical characteristics STWH13009

2.1 Electrical characteristic (curves)

Figure 2. Safe operating area

Figure 3. Derating curve



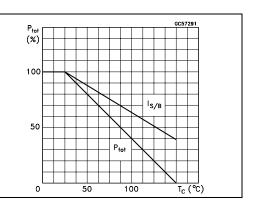
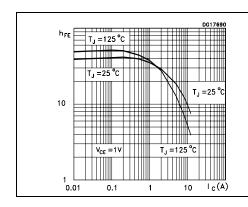


Figure 4. DC current gain

Figure 5. DC current gain



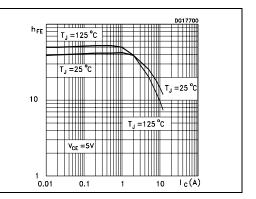
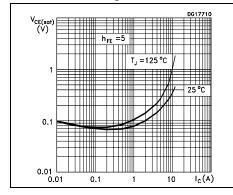
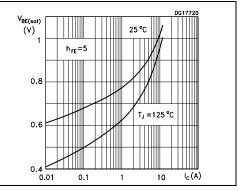


Figure 6. Collector-emitter saturation voltage

Figure 7. Base-emitter saturation voltage





STWH13009 **Electrical characteristics**

10 l_c(A)

operating area DG17740 t (n s) [l_c(A) $V_{Clamp} = 250V$ $V_{BE(off)} = -5V$ $h_{FE} = 5$ 2 I $_{B1} = -I _{B2}$ 24 20 1000 16 $R_{BB}\!=\!0\,\Omega$ 12 $h_{FE} = 7$ 100 10 0

200

400

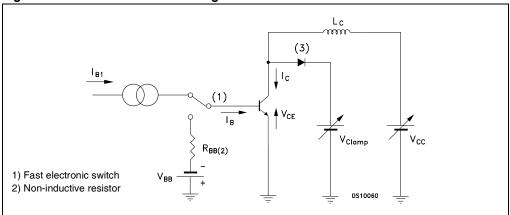
600

800 V_{CE}(V)

Inductive load switching time Figure 9. Reverse biased safe Figure 8.

2.2 **Test circuit**

Figure 10. Inductive load switching test circuit



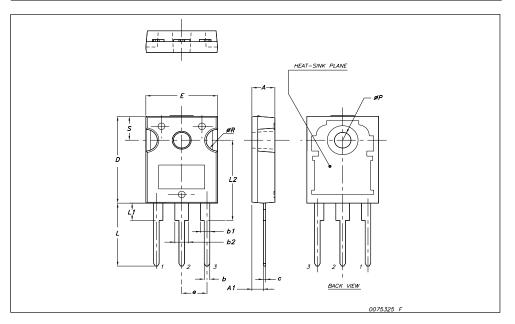
3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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TO-247 Mechanical data

Dim.	mm.			
	Min.	Тур	Max.	
Α	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
С	0.40		0.80	
D	19.85		20.15	
E	15.45		15.75	
е		5.45		
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
øΡ	3.55		3.65	
øR	4.50		5.50	
S	·	5.50		



Revision history STWH13009

4 Revision history

Table 5. Document revision history

Date	Revision	Changes
19-Oct-2007	1	Initial Release

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